



# 120V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

## **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Tc = +25°C (Note 10)
120V	$8.9 \text{m}\Omega$ @ V <sub>GS</sub> = 10V	84A
1200	16mΩ @ V <sub>GS</sub> = 6V	70A

#### **Features**

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- Thermally Efficient Package Cooler Running Applications
- High Conversion Efficiency
- Low RDS(ON) Minimizes On-State Losses
- <1.1mm Package Profile Ideal for Thin Applications</li>
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

## **Description and Applications**

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

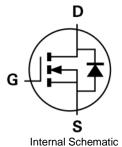
- Switchings
- DC-DC Converters

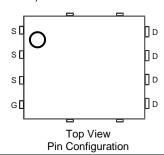
#### **Mechanical Data**

- Package: PowerDI<sup>®</sup>5060-8
- Package Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe.
   Solderable per MIL-STD-202, Method 208 3
- Weight: 0.097 grams (Approximate)









## Ordering Information (Note 4)

Part Number	Package	Packing		
	Package	Qty.	Carrier	
DMTH12H007SPS-13	PowerDI5060-8	2.500	Tape & Reel	

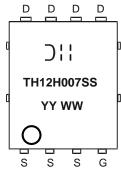
Notes:

1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.

Pin1

- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

### **Marking Information**



TH12H007SS = Product Type Marking Code
YYWW = Date Code Marking
YY = Last Two Digits of Year (ex: 22 = 2022)
WW = Week Code (01 to 53)



# **Maximum Ratings** (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	VDSS	120	V	
Gate-Source Voltage			±20	V
Continuous Drain Current, V <sub>GS</sub> = 10V (Note 6)	$T_{C} = +25^{\circ}C$ (Note 10) $T_{C} = +100^{\circ}C$	lσ	84 60	А
Pulsed Drain Current (10µs Pulse, T <sub>C</sub> = +25°C, Package Limited)	Ірм	336	Α	
Continuous Body Diode Forward Current (Note 6) T <sub>C</sub> = +25°C		ls	84	Α
Pulsed Body Diode Current (10µs Pulse, T <sub>C</sub> = +25°C, Package Limited) T <sub>C</sub> = +25°C		lsм	336	Α
Avalanche Current, L = 3mH (Note 9)	I <sub>AS</sub>	15.5	Α	
Avalanche Energy, L = 3mH (Note 9)	Eas	360.4	mJ	

## **Thermal Characteristics**

Characteristic	Symbol	Value (Typ.)	Unit
Total Power Dissipation (Note 5)	PD	3.5	W
Thermal Resistance, Junction to Ambient (Note 5)	Reja	43	°C/W
Total Power Dissipation (Note 6)	PD	125	W
Thermal Resistance, Junction to Case (Note 6)	Rejc	1.2	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +175	°C

# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

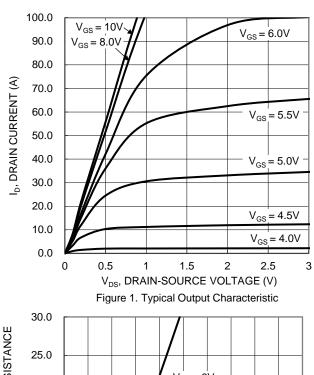
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	120	-		V	$V_{GS} = 0V$ , $I_D = 10mA$	
Zero Gate Voltage Drain Current	IDSS	_		1	μA	V <sub>DS</sub> = 96V, V <sub>GS</sub> = 0V	
Gate-Source Leakage	IGSS	_		±100	nA	$V_{GS} = \pm 20V$ , $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	2		4	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$	
Static Drain-Source On-Resistance		_	7.5	8.9	mΩ	V <sub>G</sub> S = 10V, I <sub>D</sub> = 30A	
Static Drain-Source On-Resistance	Rds(on)		12	16	11122	V <sub>G</sub> S = 6V, I <sub>D</sub> = 10A	
Diode Forward Voltage	V <sub>SD</sub>	_	0.8	1.2	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 30A	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	3142			V <sub>DS</sub> = 60V, V <sub>GS</sub> = 0V, f = 1MHz	
Output Capacitance	Coss	_	665	_	pF		
Reverse Transfer Capacitance	Crss		29	_			
Gate Resistance	R <sub>G</sub>		1.9	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge (VGS = 10V)	Qg	_	44	_			
Gate-Source Charge	Qgs	_	15	_	nC	V <sub>DS</sub> = 60V, I <sub>D</sub> = 25A	
Gate-Drain Charge	$Q_{gd}$	_	9	_			
Turn-On Delay Time	tD(ON)	_	12.5	_			
Turn-On Rise Time	t <sub>R</sub>	_	13.7	_	20	$V_{DD} = 60V, V_{GS} = 10V,$	
Turn-Off Delay Time	tD(OFF)	_	24.4	_	ns	$I_D = 25A, R_G = 2.7\Omega$	
Turn-Off Fall Time	t <sub>F</sub>	_	10.9	_			
Reverse Recovery Time	trr		55	_	ns	1- 25A di/dt - 100A/up	
Reverse Recovery Charge	Q <sub>RR</sub>	_	105	_	nC	F = 25A, di/dt = 100A/μs	

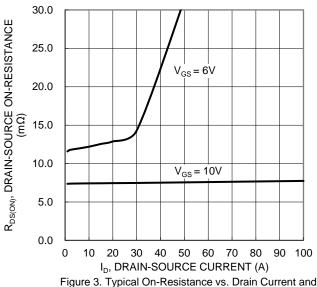
5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
6. Thermal resistance from junction to soldering point (on the exposed drain pad).
7. Short duration pulse test used to minimize self-heating effect.
8. Guaranteed by design. Not subject to product testing.

9.  $I_{AS}$  and  $E_{AS}$  ratings are based on low frequency and duty cycles to keep  $T_J$  = +25°C.

10. Package limited.







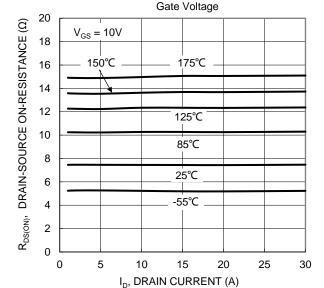
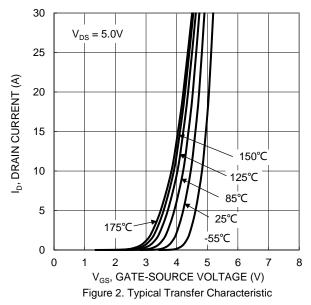
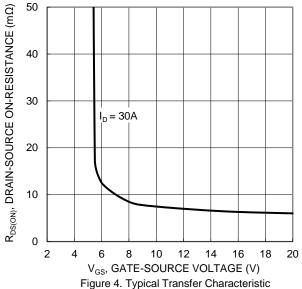


Figure 5. Typical On-Resistance vs. Drain Current and Temperature





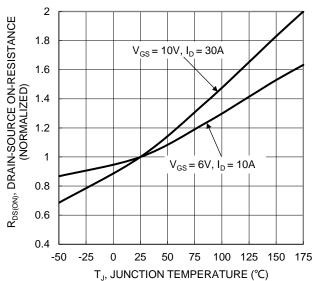


Figure 6. On-Resistance Variation with Temperature



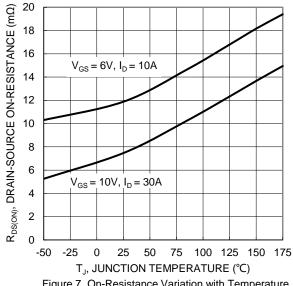


Figure 7. On-Resistance Variation with Temperature

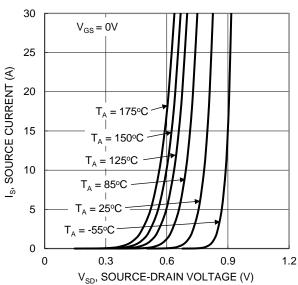


Figure 9. Diode Forward Voltage vs. Current

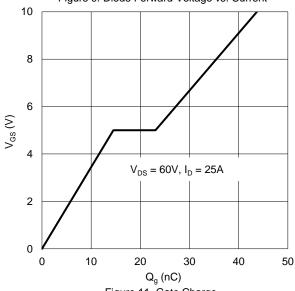


Figure 11. Gate Charge

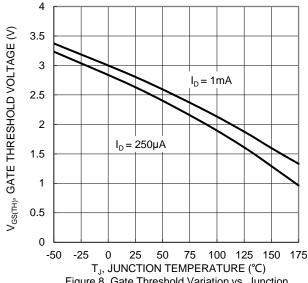


Figure 8. Gate Threshold Variation vs. Junction Temperature

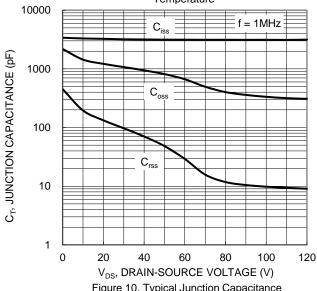
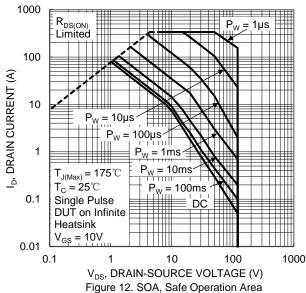


Figure 10. Typical Junction Capacitance





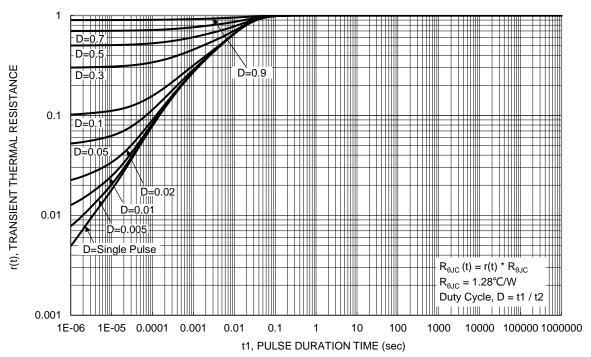


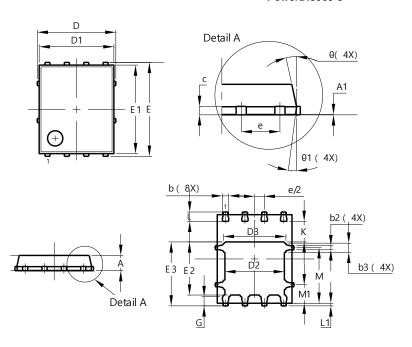
Figure 13. Transient Thermal Resistance



## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### PowerDI5060-8

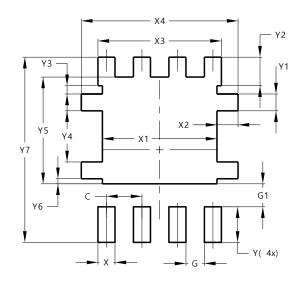


PowerDI5060-8					
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A1	0.00	0.05	1		
b	0.33	0.51	0.41		
b2	0.200	0.350	0.273		
b3	0.40	0.80	0.60		
С	0.230	0.330	0.277		
D	;	5.15 BSC			
D1	4.70	5.10	4.90		
D2	3.70	4.10	3.90		
D3	3.90	4.30	4.10		
Е	6.15 BSC				
E1	5.60	6.00	5.80		
E2	3.28	3.68	3.48		
E3	3.99	4.39	4.19		
е	1.27 BSC				
G	0.51	0.71	0.61		
K	0.51	-	1		
L	0.51	0.71	0.61		
L1	0.100	0.200	0.175		
М	3.235	4.035	3.635		
M1	1.00	1.40	1.21		
Θ	10°	12°	11°		
Θ1	6°	8°	7°		
All Dimensions in mm					

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### PowerDI5060-8



Dimensions	Value (in mm)
C	1.270
G	0.660
G1	0.820
Х	0.610
X1	4.100
X2	0.755
Х3	4.420
X4	5.610
Υ	1.270
Y1	0.600
Y2	1.020
Y3	0.295
Y4	1.825
Y5	3.810
Y6	0.180
Y7	6.610



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